

**Certifications**

Approved by ENEDIS

**Section**

MV Semi-conductor

**Application**Field  
Laboratory**PRODUCT BENEFITS**

Tool preset in factory safer than glass

**TOOL CAPACITY**

|          |                                   |
|----------|-----------------------------------|
| Diameter | 15 - 240 mm<br>0,591 - 9,449 inch |
|----------|-----------------------------------|

**TOOL DIMENSIONS**

|                    |         |
|--------------------|---------|
| Length             | 250 mm  |
| Width              | 40 mm   |
| Height             | 25 mm   |
| Weight without box | 0,19 Kg |
| Packaging          | Box     |

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## Scraper for residues of bonded semiconductor screen.

**TO DO WHAT**

The tool GRI enables the user to remove bonded semiconductor screen residus.

**Options**

EGR - Pouch for GRI

**Spare part**

LGR - Spare balde scrape semiconductor

**Associated tool**

CWB/18-60-FEP - Tool to remove bonded semiconductor with chamfer on the semiconductor cutback

BRMRD1E - Tool to remove insulation

MV cables Tools

# GRI



| Part Number | Diameter                        | Tool capacity | Dimensions         |                   |                   | Packaging |
|-------------|---------------------------------|---------------|--------------------|-------------------|-------------------|-----------|
|             |                                 |               | Length             | Width             | Height            |           |
| GRI         | 15 - 240 mm<br>0,591 - 9,449 in |               | 250 mm<br>9,843 in | 40 mm<br>1,575 in | 25 mm<br>0,984 in | box       |